Charging and discharging of Co/SiO₂ multilayer structures investigated by scanning force microscopy

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<u>Outline</u>

- 1. Motivation
- 2. Sample Structure and Experimental Procedure
- 3. Results and Discussion
- 4. Conclusion







- Discontinuous ferromagnetic metal/insulator multilayers exhibit a variety of properties important for magnetic recording and other memory applications:
 - formation of metal nanoclusters separated by insulator
 - negative magnetoresistance due to spin-dependent tunneling
 - saturation of magnetoresistance at low magnetic fields
- Detailed study of electrical transport properties necessary to improve devices
- Scanning probe techniques allow local study in contrast to usual large scale electrodes
- Study of local charging/discharging of metal particles → insights in electrical transport properties of discontinous metal/insulator multilayers

Sample Preparation and Structure

- Alternate sputtering from two separate targets on n-type Si substrate covered with ~2.5 nm native oxide
- Nominal deposited film structure: 3 nm SiO₂ / 1.4 nm Co / 3 nm SiO₂

Experimental Procedure

- Scanning Force Microscope
- Two pass method:
 - 1) Topography (via TappingMode[™])
 - 2) Electrostatic Force Microscopy (EFM)

$$\Delta f = \frac{f_0}{2k} \frac{\partial F}{\partial z}$$

• Charging:

Hold oscillating tip during first pass for 10 s in center of scan area and apply a voltage V_{ch} between tip and substrate



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2. Sample Structure and Experimental Procedure

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Measurement of stored charge via EFM:

Force on tip:

$$F(z) = \frac{1}{(z + (d_1 + d_2) / e_{\text{SiO}_2})^2} \times \left(-\frac{d_2^2 Q^2}{e_{\text{SiO}_2}^2 e_0 A} + \frac{2d_2 Q V_{\text{EFM}}}{e_{\text{SiO}_2}} + \frac{e_0 A V_{\text{EFM}}^2}{2} \right)$$

- Model calculations + measurements show that first term in bracket is small and can be neglected
- \bullet last term constant for all points in scan area \rightarrow does not contribute to contrast

Inserting parameters in F(z) and calculating $\Delta f \Rightarrow Q \approx 18.4 \frac{e}{VHz} V_{EFM} \Delta f$



3. Results and Discussion Nanoscale Characterization and Devices Research Group Daniel M. Schaadt **Charging** 2.0 Hz 1.0 Hz • Charging with +12 V for 10 s: 0.0 Hz before after $V_{\rm EFM} = 1 \, {\rm V}$ $V_{\text{EFM}} = -1 \text{ V}$ 500 nm

• Charging with -12 V for 10 s:

before after
$$V_{\text{EFM}} = 1 \text{ V}$$
 $V_{\text{EFM}} = -1 \text{ V}$



Dependence on voltage, charged area



Tip oscillates during charging with amplitude $B \rightarrow$ average capacitance:

$$\overline{C} = \frac{e_0 A}{2B} \int_0^{2B} \frac{1}{z + (d_1 + d_2)/e_{\text{SiO}_2}} dz$$
$$= \frac{e_0 A}{2B} \ln \frac{2B + (d_1 + d_2)/e_{\text{SiO}_2}}{(d_1 + d_2)/e_{\text{SiO}_2}}$$
$$= 2.18 \times 10^{-8} \,\text{F/cm}^2$$

 \Rightarrow Charged area: $A = \overline{C} / C_{\rm m} = 1.10 \times 10^{-11} {\rm cm}^2$

with $A = \mathbf{p} r^2 \implies r \approx 20 \text{ nm} \iff r_{Tip} \approx 10 - 20 \text{ nm}$

compare with r_{Tip} and $r_{EFM} \approx 50 \text{ nm} \implies r_{EFM} \approx r + r_{Tip}$

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Gradual decrease in peak height, slight increase in area

⇒ Most of the stored charge tunnels into the Si substrate while part of it spreads out in the Co layer

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Charging with +12 V for 10 s



- Exponential discharging with constant retention time τ_{\pm} : $Q(t) = Q_0 e^{-t/t_{\pm}}$
- $\tau_+ > \tau_-$

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- Coulomb energy for cluster with capacitance C_{Co} : $E_0 = \frac{e^2}{2C_{\text{Co}}}$
- Discharging from Co cluster into substrate Barrier heights:

Positive charge on cluster: $f_+ = \overline{f} + E_0$

Negative """ $f_{-} = \overline{f} - E_{0}$ $E_{F} - E_{0}$

with average barrier height $\overline{f} = \frac{f_0 + f_1}{2}$

• Tunnel probability ~
$$e^{\frac{2d_2\sqrt{2mef}}{\hbar}} \Rightarrow \frac{t_+}{t_-} \approx e^{\frac{2d_2\sqrt{2me}}{\hbar}(\sqrt{f_+}-\sqrt{f_-})}$$

- d_2 and E_0 strongly dependent upon nominal Co layer thickness
- Additional discharging between Co cluster









- Controllable and reproducible charge deposition in Co clusters embedded in SiO₂
- Charge decays over several minutes with retention time τ_+ for positive charge larger than τ_- for negative charge
- Difference in retention times for positive and negative charge is explained by Coulomb blockade
- Retention times are strongly dependent upon film composition implications for dynamics of charge transport in discontinuous multilayers and granular films
- Longer retention times can be achieved with thicker lower oxide and techniques such as nanoscale patterning to suppress discharging between Co cluster